

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc3210eud-1#pbf

(Engineering Calculation)

QFN 3mm X 3mm Exp. Pad

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**TOTAL MASS (g) : 0.02327**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001010	1000000	43403.9726562		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.008752	975000	376110.4375		
		Iron (Fe)	7439-89-6	0.000215	24000	9239.45898438		
		Phosphorus (P)	7723-14-0	0.000003	300	128.922698975		
		Zinc (Zn)	7440-66-6	0.000006	700	257.845397949		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.008976</b>	<b>1000000</b>	<b>385736.71875</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000413	1000000	17738.09375		
		<b>External Plating Total:</b>				<b>0.000413</b>	<b>1000000</b>	<b>17738.09375</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000203	1000000	8723.76855469		
<b>Internal Plating Total:</b>				<b>0.000203</b>	<b>1000000</b>	<b>8723.76855469</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000571	750000	24538.2832031		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000190	250000	8165.10449219		
<b>Die Attach Total:</b>				<b>0.000761</b>	<b>1000000</b>	<b>32703.3886719</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001534	130000	65922.46875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010148	860000	436102.46875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000118	10000	5070.95898438		
		<b>Encapsulation Total:</b>				<b>0.011800</b>	<b>1000000</b>	<b>507095.9375</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000107	1000000	4598.24267578		
					<b>TOTAL MASS (g) :</b>	<b>0.02327</b>		